Date: 1	1/9/2010		PMP5959 REVB BOM			
COUNT	RefDes	Value	Description	Size	Part Number	Mfr
	C7, C12	0.1uF	Capacitor, Ceramic, 25V, X7R, 10%	0603	Std	Std
2	C5, C16	1000pF	Capacitor, Ceramic, 50V, X7R,10%	0603	Std	Std
1	C8	15pF	Capacitor, Ceramic, 50V, NPO, 10%	0603	Std	Std
1	C13	1uF	Capacitor, Ceramic, 16V, X7R, 10%	0603	Std	Std
1	C9	2700pF	Capacitor, Ceramic, 50V, X7R,10%	0603	Std	Std
1	C15	0.1uF	Capacitor, Ceramic, 50V, X7R, 15%	0805	Std	TDK
1	C14	4.7uF	Capacitor, Ceramic, 16V, X7R, 15%	0805	Std	TDK
2	C1, C11	4.7uF	Capacitor, Ceramic, 50V, X7R, 15%	1210	C3225X7R1H475MT	TDK
4	C2, C3, C4, C10	150uF	Capacitor, Alum, 50V, 979mArms	0.315 inch	50VZL150uF20%10x12.5mm	Rubycon
1	L1	22uH	Inductor, 11A, 14.6 milliohms	18.2x18.3mm	74435572200	WE
2	Q1, Q2	BSC110N06NS3G	MOSFET, Nch, 60V, 50A, 11 milliohm	TDSON-8	BSC110N06NS3G	Infineon
1	R7	0	Resistor, Chip, 1/16-W, 1%	0603	Std	Std
1	R5	10	Resistor, Chip, 1/16-W, 1%	0603	Std	Std
1	R17	49.9	Resistor, Chip, 1%, 0603	0603	Std	Std
1	R16	100K	Resistor, Chip, 1/16-W, 1%	0603	Std	Std
4	R9, R12, R14, R18	10K	Resistor, Chip, 1/16-W, 1%	0603	Std	Std
1	R3	6.81K	Resistor, Chip, 1/16-W, 1%	0603	Std	Std
-	R15	2.10K	Resistor, Chip, 1/16-W, 1%	0603	Std	Std
1	R19	21.5K	Resistor, Chip, 1/16-W, 1%	0603	Std	Std
	R10	43.2K	Resistor, Chip, 1/16-W, 1%	0603	Std	Std
1	R13	38.3K	Resistor, Chip, 1/16-W, 1%	0603	Std	Std
1	R4	24.9K	Resistor, Chip, 1/16-W, 1%	0603	Std	Std
2	R1, R2	24.9K	Resistor, Chip, 1/16-W, 1%	0603	Std	Std
1	U1	TPS40170RGY	IC, 4.5V-60V Sync Buck Controller	QFN-20	TPS40170RGY	TI
	01	1F340170KG1	IC, 4.5V-00V Sylic Buck Controller	QFIN-20	1F340170KG1	11
MISC						
1	J1	PEC03SAAN	Header, Male 3-pin, 100mil spacing,	0.100 inch x 3	PEC03SAAN	Sullins
1	J2	B3P-VH	Connector, 3-pin, Top, 0.156" spacing	0.426"x0.335"	B3P-VH	JST
1	J3	B2P-VH	Connector, 2-pin, Top, 0.156" spacing	0.465"x0.370"	B2P-VH	JST
	TP1, TP2, TP5, TP6, TP7, TP8,					
9	TP11, TP12, TP13		Test Point, Red, 1mm	0.038"	240-345	Farnell
4	TP3, TP9, TP10, TP14		Toot Point Block 1mm	0.038"	240 222	Fornell
		DNP	Test Point, Black, 1mm		240-333	Farnell
3	R6, R8, R11		Resistor, Chip, 1/16-W, 1%	0603	Std	Std
1	C6	DNP	Capacitor, Ceramic, 50V, X7R,10%	0603	Std	Std

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

Applications

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products

OMAP Mobile Processors www.ti.com/omap

www.ti.com/wirelessconnectivity

Wireless Connectivity

		· · · p p · · · · · · · · · ·	
Audio	www.ti.com/audio	Automotive and Transportation	www.ti.com/automotive
Amplifiers	amplifier.ti.com	Communications and Telecom	www.ti.com/communications
Data Converters	dataconverter.ti.com	Computers and Peripherals	www.ti.com/computers
DLP® Products	www.dlp.com	Consumer Electronics	www.ti.com/consumer-apps
DSP	dsp.ti.com	Energy and Lighting	www.ti.com/energy
Clocks and Timers	www.ti.com/clocks	Industrial	www.ti.com/industrial
Interface	interface.ti.com	Medical	www.ti.com/medical
Logic	logic.ti.com	Security	www.ti.com/security
Power Mgmt	power.ti.com	Space, Avionics and Defense	www.ti.com/space-avionics-defense
Microcontrollers	microcontroller.ti.com	Video and Imaging	www.ti.com/video
RFID	www.ti-rfid.com		

TI E2E Community Home Page

e2e.ti.com